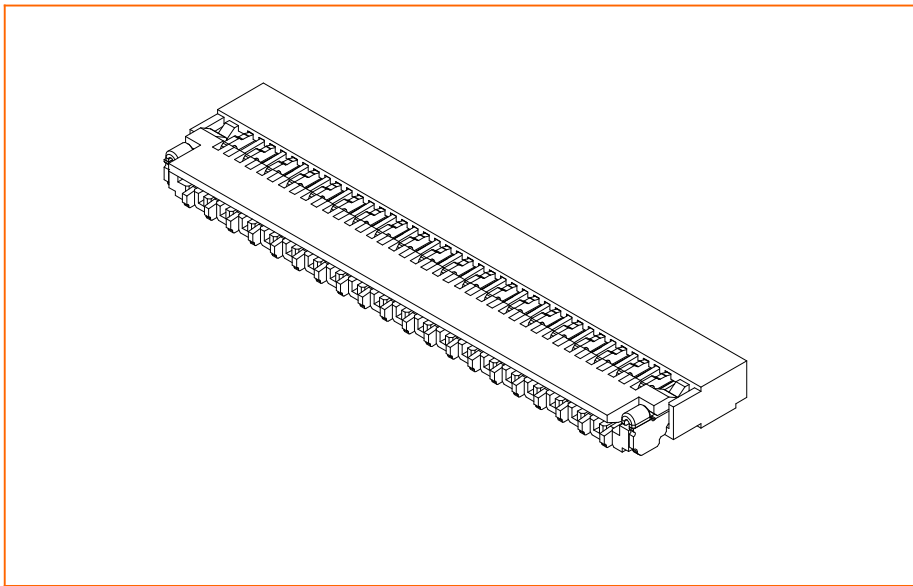


**Product Specification**

深圳臺華達科技有限公司 **SHENZHEN THD Electronics Co., Ltd.**  
T



**Product.No**

**THD0310 – xxCL – GF**

**Pitch=0.30mm,H=1.0mm FPC Connector (Front-Flip Lower Contact)**

A	Release
Rev.	Description

**Approved Signatures**

■Prepared By : JIM	■Date: 2010.06.24
■Checked By : JIM	■Date: 2010.06.24
■Approved By : Jacky	■Date: 2010.06.24

## ■ Scope

This specification covers the 0.3 mm Pitch FPC Connector THD0310 series.

## ■ Ordering information

### THD0310 - xx CL - GF

①                      ②                      ③                      ④

①	Series name : THD0310	④	Plating : GF= 1μ"~3μ" Gold Flash G3= 3μ" Gold over Nickel G5= 5μ" Gold over Nickel
②	Number of contacts : 9 TO 71		
③	Contact type : CL:Lower contact		

## ■ Rating

Item	Standard
Voltage Rating(Max.)	30V AC
Current Rating(Max.)	0.2A DC
Operating Temperature Range	-25°C ~ +85°C (Including terminal temperature rise)

## ■ Material

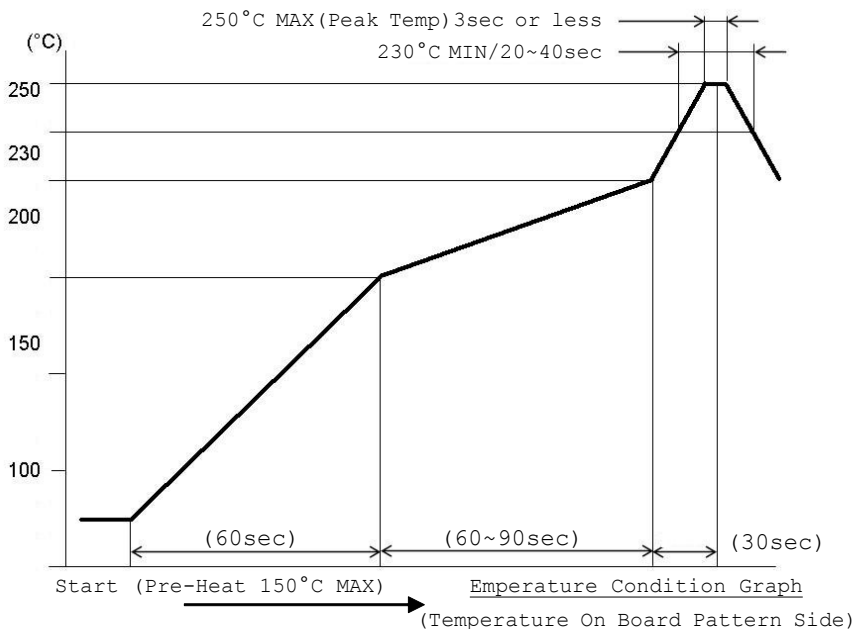
Housing	Actuator	Terminal	Solder pin	Plating
L.C.P (UL94V-0)	L.C.P (UL94V-0)	Copper alloy	Copper alloy	1μ"~3μ" Gold over Nickel
Color : White	Color : Black			

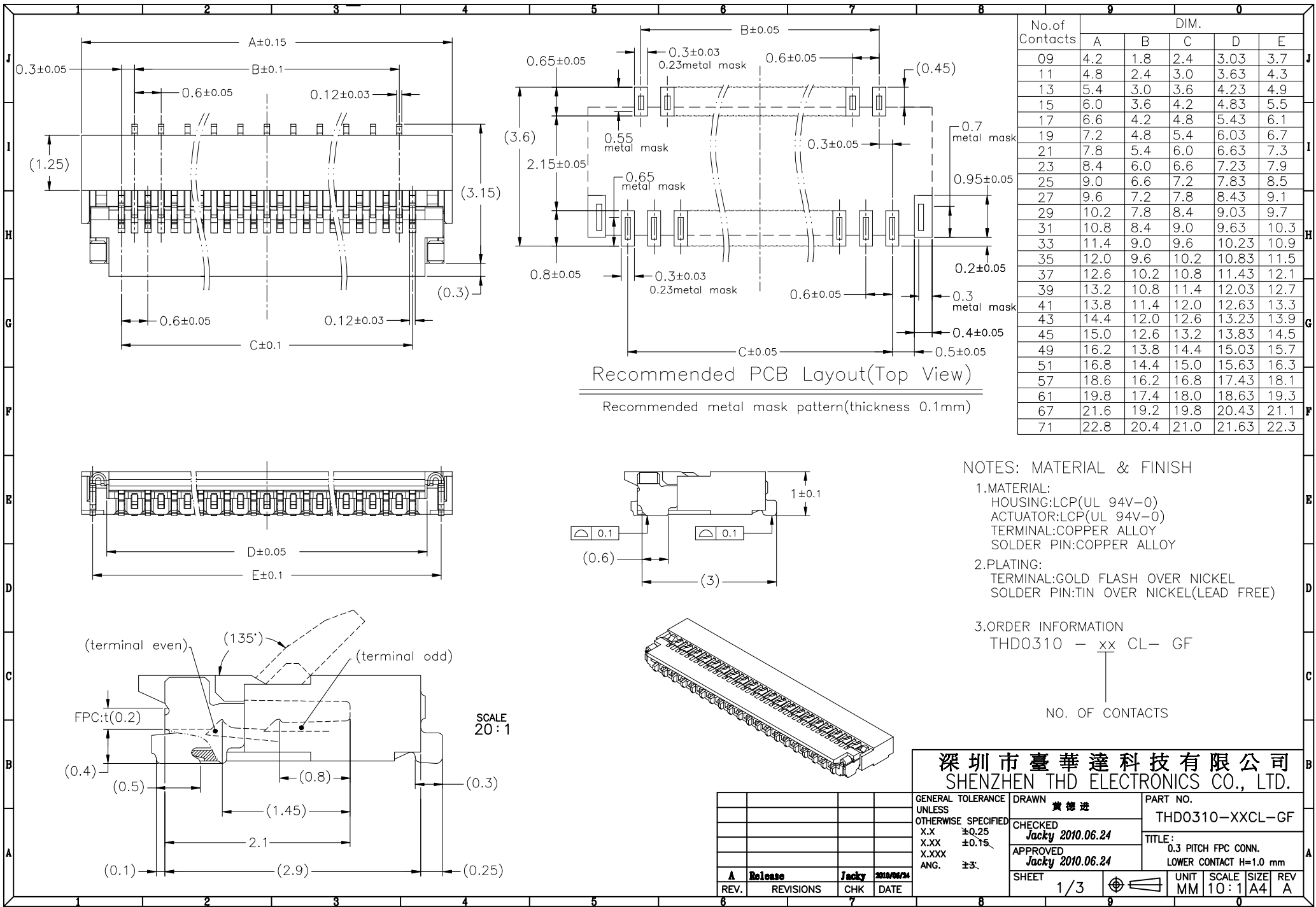
## ■ Performance

Item	Test Condition	Specification	
Contact Resistance	Mate applicable FPC and measure by dry circuit, 20mV Max, 10mA.	30 mΩ Max.	
Insulation Resistance	Mate applicable FPC and apply 500V DC between adjacent terminal or ground.	100 MΩ Min.	
Dielectric Strength	Mate applicable FPC, apply 250V AC(rms) for 1 minute between adjacent terminal or ground.	No Breakdown	
FPC Retention Force	Insert the actuator, pull the FPC at a rate of 25±3mm per minute.	Per pin x 0.03N Min.	
Terminal Retention Force	Apply axial pull out force at the rate of 25±3 mm/minute on the terminal assembled in the housing.	Per pin x 0.1Kgf {0.3N} Min.	
Vibration	Mate connectors and subject to the following vibration conditions, for period of 2 hours in each of 3 mutually perpendicular axes, passing DC 1mA during the test.  Amplitude : 1.5mm P-P Frequency : 10~55~10 Hz in 1 minute. Duration : 2 hours in each of X,Y,Z axes.	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
		Discontinuity	1 μsec Max.
Shock	Mate applicable FPC and subject to the following shock conditions. 3 times of shocks shall be applied for each 6 directions along 3 mutually perpendicular axes, passing DC 1 mA current during the test.  Peak value : 490m/s <sup>2</sup> {50G}	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
		Discontinuity	1 μsec Max.
Salt Spray	Mate applicable FPC and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water, after which the specified measurements shall be performed.  NaCl solution Concentration : 5 ± 1% Spray time : 48 ± 4 hours Ambient temperature : 35 ± 2°C	Appearance	No Damage
		Contact Resistance	100 mΩ Max.

Item	Test Condition	Specification	
Heat Resistance	Mate applicable FPC and expose to 85±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
Cold Resistance	Mate applicable FPC and expose to -40±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
Humidity	Mate applicable FPC and expose to 60 ± 2°C, relative humidity 90 to 95% for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
		Dielectric Strength	No Breakdown
		Insulation Resistance	50 MΩ Min.
Temperature Rise	Mate applicable FPC and measure the temperature rise of contact when the maximum AC rated current is passed.	Temperature rise	30°C Max.
Temperature Cycling	Mate applicable FPC and subject to the following conditions for 5 cycles. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. 1 cycle a) -55±3°C      30minutes b) +85±3°C      30minutes (Transit time shall be with in 3 minutes)	Appearance	No Damage
		Contact Resistance	100 mΩ Max.
Solderability	Tip of solder tails and fitting nails into the molten solder (held at 245±5°C) up to 0.1mm from the bottom of the housing for 3±0.5 seconds.	Solder Wetting	95% of immersed area must show no voids, pin holes.
Resistance to Soldering	When reflowing refer to Infrared reflow condition <i>Soldering iron method</i> 0.2mm from terminal tip and fitting nail tip. Soldering time : 5 seconds Max. Solder temperature : 370~400°C	Appearance	No Damage

### ■ Recommended Temperature Profile





No. of Contacts	DIM.				
	A	B	C	D	E
09	4.2	1.8	2.4	3.03	3.7
11	4.8	2.4	3.0	3.63	4.3
13	5.4	3.0	3.6	4.23	4.9
15	6.0	3.6	4.2	4.83	5.5
17	6.6	4.2	4.8	5.43	6.1
19	7.2	4.8	5.4	6.03	6.7
21	7.8	5.4	6.0	6.63	7.3
23	8.4	6.0	6.6	7.23	7.9
25	9.0	6.6	7.2	7.83	8.5
27	9.6	7.2	7.8	8.43	9.1
29	10.2	7.8	8.4	9.03	9.7
31	10.8	8.4	9.0	9.63	10.3
33	11.4	9.0	9.6	10.23	10.9
35	12.0	9.6	10.2	10.83	11.5
37	12.6	10.2	10.8	11.43	12.1
39	13.2	10.8	11.4	12.03	12.7
41	13.8	11.4	12.0	12.63	13.3
43	14.4	12.0	12.6	13.23	13.9
45	15.0	12.6	13.2	13.83	14.5
49	16.2	13.8	14.4	15.03	15.7
51	16.8	14.4	15.0	15.63	16.3
57	18.6	16.2	16.8	17.43	18.1
61	19.8	17.4	18.0	18.63	19.3
67	21.6	19.2	19.8	20.43	21.1
71	22.8	20.4	21.0	21.63	22.3

Recommended PCB Layout(Top View)  
Recommended metal mask pattern(thickness 0.1mm)

NOTES: MATERIAL & FINISH

- MATERIAL:  
HOUSING:LCP(UL 94V-0)  
ACTUATOR:LCP(UL 94V-0)  
TERMINAL:COPPER ALLOY  
SOLDER PIN:COPPER ALLOY
- PLATING:  
TERMINAL:GOLD FLASH OVER NICKEL  
SOLDER PIN:TIN OVER NICKEL(LEAD FREE)

3.ORDER INFORMATION

THD0310 - xx CL- GF

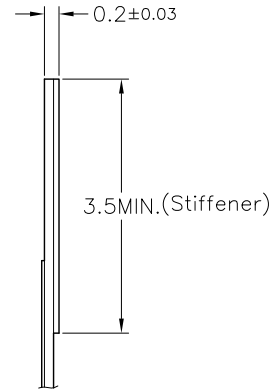
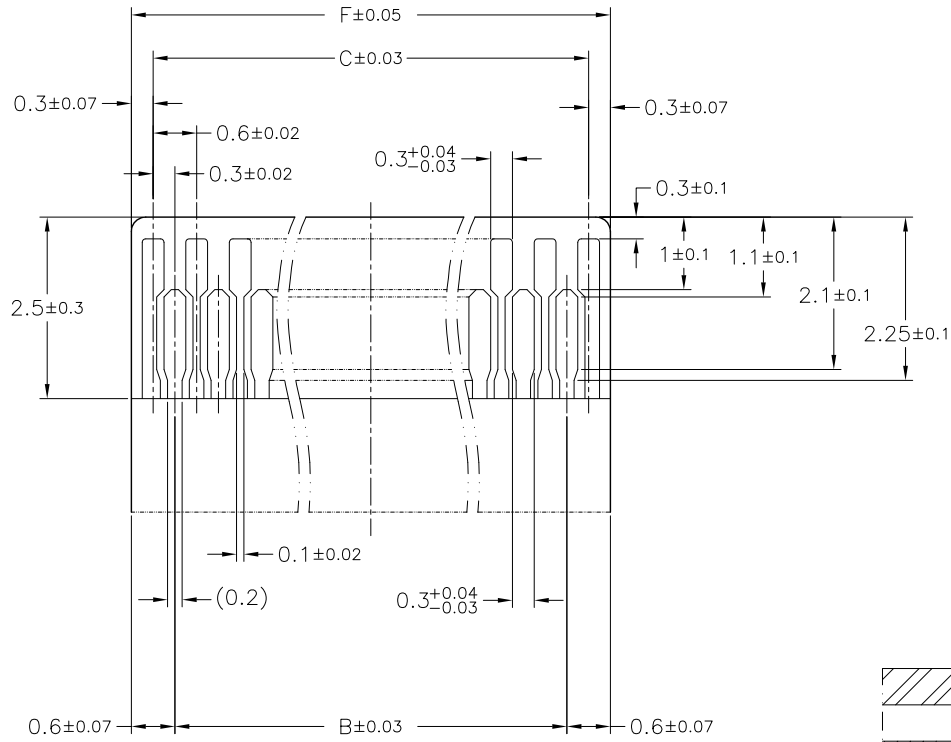
NO. OF CONTACTS

深圳市臺華達科技有限公司  
SHENZHEN THD ELECTRONICS CO., LTD.

GENERAL TOLERANCE UNLESS OTHERWISE SPECIFIED		DRAWN 黃德達		PART NO.	
X.X	±0.25	CHECKED		THD0310-XXCL-GF	
X.XX	±0.15	Jacky 2010.06.24		TITLE:	
X.XXX	±0.1	APPROVED		0.3 PITCH FPC CONN.	
ANG.	±3°	Jacky 2010.06.24		LOWER CONTACT H=1.0 mm	
A Release	Jacky	2010/06/24	SHEET	UNIT	SCALE
REV.	REVISIONS	CHK	DATE	MM	10:1
				1/3	A4

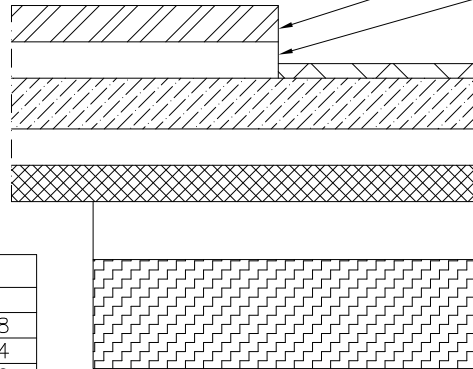
SCALE 20:1

# Recomenend FPC



# Recomenend FPC Construction

Materoial name	Material	Thickness (mm)
Covering flim layer & Cover adhesive	Polyamide	0.025
Surface teratment	Plating treatment	0.005
Copper foil	Cu	0.035
Base adhesive	Heat-Hardened adhesive	0.025
Base flim	Polyamide	0.025
Reinforcement material adhesive	Heat-Hardened adhesive	0.040
Stiffener	Polyamide	0.075



No.of Contacts	DIM.		
	B	C	F
09	1.8	2.4	3.0
11	2.4	3.0	3.6
13	3.0	3.6	4.2
15	3.6	4.2	4.8
17	4.2	4.8	5.4
19	4.8	5.4	6.0
21	5.4	6.0	6.6
23	6.0	6.6	7.2
25	6.6	7.2	7.8
27	7.2	7.8	8.4
29	7.8	8.4	9.0
31	8.4	9.0	9.6
33	9.0	9.6	10.2

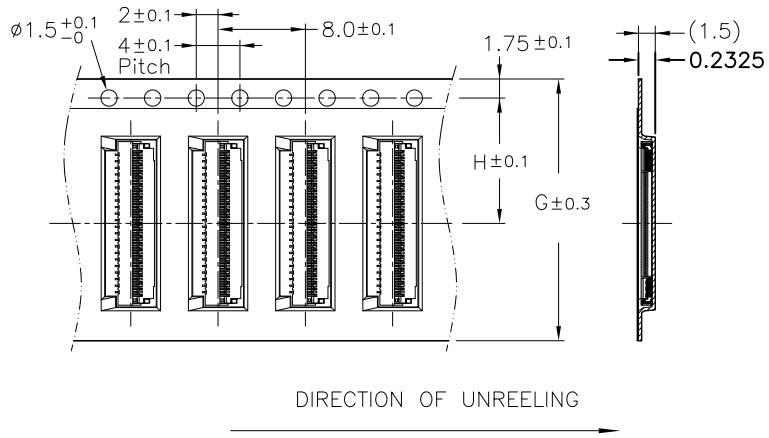
No.of Contacts	DIM.		
	B	C	F
35	9.6	10.2	10.8
37	10.2	10.8	11.4
39	10.8	11.4	12.0
41	11.4	12.0	12.6
43	12.0	12.6	13.2
45	12.6	13.2	13.8
49	13.8	14.4	15.0
51	14.4	15.0	15.6
57	16.2	16.8	17.4
61	17.4	18.0	18.6
67	19.2	19.8	20.4
71	20.4	21.0	21.6

REV.	REVISIONS	CHK	DATE
A	Release	Jacky	2010/06/24

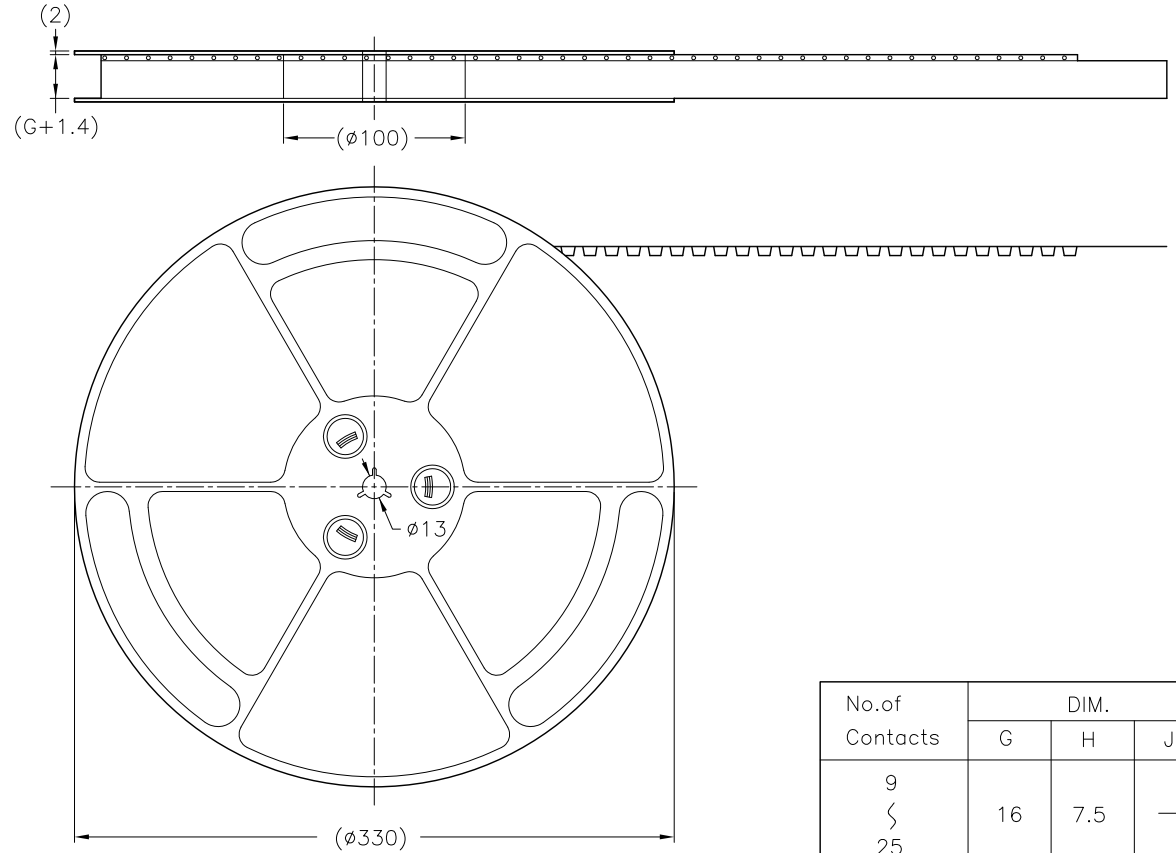
**深圳臺華達科技有限公司**  
 SHENZHEN THD ELECTRONICS CO., LTD.

GENERAL TOLERANCE UNLESS OTHERWISE SPECIFIED X.X ±0.25 X.XX ±0.15 X.XXX ±0.1 ANG. ±3°	DRAWN 黄德进 CHECKED Jacky 2010.06.24 APPROVED Jacky 2010.06.24	PART NO. THD0310-XXCL-GF TITLE: 0.3 PITCH FPC CONN. LOWER CONTACT H=1.0
	SHEET 2/3	UNIT MM SCALE 10:1 SIZE A4 REV A

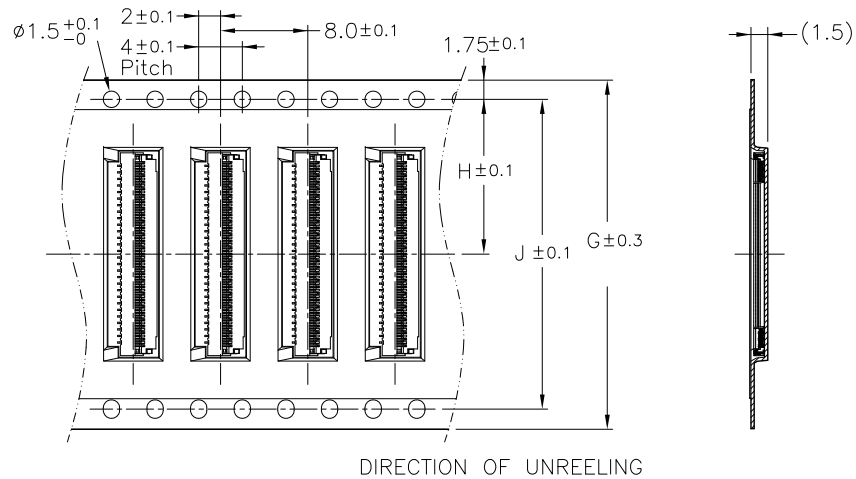
### Tape width 16 and 24 mm



### REEL Dim



### Tape width 32 and 44 mm



No.of Contacts	DIM.		
	G	H	J
9 ∩ 25	16	7.5	—
27 ∩ 51	24	11.5	—
57 ∩ 67	32	14.2	28.4
71	44	20.2	40.4

#### Notes:

- 1.PER REEL : 5000pcs.
- 2.Material : Black Conductive Polystyrene Alloy.
- 3.Thickness :  $0.3 \pm 0.05$ mm.
- 4.All dimensions meet EIA-481-C requirements.

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SHENZHEN THD ELECTRONICS CO., LTD.

REV.	REVISIONS	CHK	DATE
A	Release	Jacky	2010/06/24

GENERAL TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN 黄德进 2010.06.24	PART NO. THD0310-XXCL-GF
X.X ±0.25	CHECKED Jim 2010.06.24	TITLE: 0.3 PITCH FPC CONN.
X.XX ±0.15	APPROVED Jim 2010.06.24	LOWER CONTACT H=1.0MM
X.XXX ANG. ±3'	SHEET 3/3	UNIT MM SCALE SIZE REV A4 A

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